ICSP9

Jack Champaigne Chosen as Keynote Speaker

Mishawaka, Indiana. Jack Champaigne, President of Electronics, Inc., has accepted the honor of being a keynote speaker at the ninth International Conference on Shot Peening (ICSP9) in Paris, September, 2005. Mr. Champaigne will make a presentation on Shot Peening Specifications. He is recognized as a

specialist in this field and has done extensive work with standardization processes in the SAE. Mr. Champaigne will also present a paper on studies of Almen strip parameters.

The ICSP conferences, held every three years at various international venues, provide a forum for the presentation and discussion of technical, scientific and academic papers related to the shot peening process. The main topics of the conference will be Technological Aspects, Processes, Surface Characteristics and their Stability, Modeling and Simulation, Fatigue and Fracture Properties and Applications, and Engineering Specifications.

Dr. -Ing. V. Schulze, a professor at the Technical University of Karlsruhe, Germany, is the chairmen of the organizing committee. For up-to-date information on the conference, visit www.shotpeener.com